

Product Specifications

Customer	Standard
Description	2.7" TFT EPD Panel
Model Name	E1271CS021
Date	2016/03/09
Doc. No.	1P094-00
Revision	0 4

Customer Approval				
	T			
Date				
	The above signature represents that the product specifications, testing regulation, and warranty in the specifications are accepted			

Design Engineering				
Approval	Check	Design		
森 2016.03.10 倉民	蘇 2016.03.10 倉民	林 2016.03.09 睦順		

4F, No.28, Chuangye Rd., Tainan Science Park., Tainan City 74144, Taiwan (R.O.C.)

Tel: +886-6-279-5399 Fax: +886-6-505-5300

Rev.: 04 Page: 1 of 29 Date: 2016/03/09



Copyright

Pervasive Displays Incorporated All rights reserved.

This document is the exclusive property of Pervasive Displays Inc. (PDI) and shall not be reproduced or copied or transformed to any other format without prior permission of PDI. (PDI Confidential)

本資料為龍亭新技股份有限公司專有之財產,非經許可,不得複製、翻印或轉變成其他形式使用。

龍亭新技股份有限公司 Pervasive Displays Inc.

4F, No.28, Chuangye Rd., Tainan Science Park., Tainan City 74144, Taiwan (R.O.C.)

Tel: +886-6-279-5399

http://www.pervasivedisplays.com

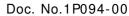
Rev.: 04 Page: 2 of 29 Date: 2016/03/09





Table of Contents

Rev	ision F	History6
Glo	ssary o	of Acronyms7
1	Gener	al Description8
	1.1	Overview8
	1.2	Features8
	1.3	Applications8
	1.4	General Specifications9
	1.5	Mechanical Specifications10
2	Absolu	ute Maximum Ratings12
	2.1	Absolute Ratings of Environment
	2.2	Reliability Test Item13
3	Electri	cal Characteristics14
	3.1	Absolute Maximum Ratings of Panel
	3.2	Recommended Operation Conditions of Panel
4	Applic	ation Circuit Block Diagram16
5	Termii	nal Pin Assignment & Reference Circuit17
	5.1	Terminal Pin Assignment
	5.2	Reference Circuit
6	Optica	ıl Characteristics
	6.1	Test Conditions
	6.2	Optical Specifications
	6.2.1	Optical
	6.2.2	2 Ghosting
7	Packir	ıg24
8	Precai	utions26
9	Defini	tion of Labels28





List of Figures

Figure 1-1	EPD Drawing	
Figure 3-1	Test Pattern of Panel	15
Figure 3-2	Image Update Current Profile	15
Figure 3-3	Current Measurement	15
Figure 4-1	Application Circuit Block Diagram	16
Figure 5-1	EPD Reference Circuit	19
Figure 6-1	Optical measurement	21
Figure 6-2	Definition of Viewing Angle to Measure Contrast Ratio	22
Figure 7-1	Packing Diagram	24
Figure 9-1	Model Labels	28
Figure 9-2	Definition of Model Labels	28
Figure 9-3	Carton Label	29
Figure 9-4	Pallet Label	29





List of Tables

Table 1-1	General Specification	C
Table 1-2	Mechanical Specification	10
Table 1-3	FPC Specification	10
Table 2-1	Absolute Ratings of Environment	12
Table 2-2	Reliability Test Items	13
Table 3-1	Absolute Maximum Ratings of Panel	14
Table 3-2	Recommended Operation Conditions of Panel	14
Table 5-1	Terminal Pin Assignment	17
Table 6-1	Optical Measurement Conditions	20
Table 6-2	Optical Measurement with D65 light source	20
Table 6-3	Measurement of Ghosting	23





Revision History

Version	Date	Page (New)	Section	Description
Ver.01	2014/11/11	All	All	Product specification first issued.
		1 and 2	Cover	Modified Product description.
Ver.02	2015/02/06		page	Modified company address.
Ve1.02	2013/02/00	9	1.4	Table 1-1, Add driver IC.
		28	9	Figure 9-1, Add model labels dimension and positon.
		11	1.9	Figure 1-1 EPD Drawing, Added silicon glue.
		12	2.1	Added Note(1), (d)
		12	2.1	Deleted Figure 2-1 Operating Range of Relative Humidity and Temperature.
Ver.03	2016/01/18	17	5.1	Table 5-1 Terminal Pin Assignment, Modified No.8.
Vei.03	2010/01/18	19	5.2	Figure 5-1 EPD Reference Circuit, Modified Pin 8.
		25	7	Modified Figure 7-1 Packing Diagram
		27	8	Precautions, Added No. (23).
		28	9	Modified Figure 9-2 Definition of Model Labels.
		29	9	Modified Figure 9-3 Carton Label.
Ver.04	2016/03/09	24	7	Modified Figure 7-1 Packing Diagram, carton label position to left side down
		29	9	Modified Figure 9-3 Carton label size to 100*100mm

Rev.: 04 Page: 6 of 29 Date: 2016/03/09



Glossary of Acronyms

EPD Electrophoretic Display (e-Paper Display)

EPD Panel EPD

TCon Timing Controller
TFT Thin Film Transistor
MCU Microcontroller Unit

FPC Flexible Printed Circuit
FPL Front Plane Laminate

SPI Serial Peripheral Interface

COG Chip on Glass

PDI Pervasive Displays Incorporated

Rev.: 04 Page: 7 of 29 Date: 2016/03/09



ERVASIVE DISPLAYS Doc. No.1P094-00

1 General Description

1.1 Overview

This is a 2.7" a-Si, active matrix TFT, Electronic Paper Display (EPD) panel. The panel has such high resolution (117 dpi) that it is able to easily display fine patterns. Due to its bi-stable nature, the EPD panel requires very little power to update and needs no power to maintain an image.

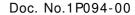
1.2 Features

- a-Si TFT active matrix Electronic Paper Display(EPD)
- Resolution: 264 x 176
- Ultra low power consumption
- Super Wide Viewing Angle near 180°
- Extra thin & light
- SPI interface
- RoHS compliant

1.3 Applications

- Electronic shelf label (ESL)
- Reusable container
- Badge

Rev.: 04 Page: 8 of 29 Date: 2016/03/09





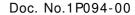
1.4 General Specifications

Table 1-1 General Specification

Item	Specification	Unit	Note
Outline Dimension	70.42(H) x 45.80(V) x 0.90(T)	mm	(1)
Active Area	57.288(H) x 38.192(V)	mm	
Driver Element	a-Si TFT active matrix	-	
FPL	Aurora Mb	-	
Pixel Number	264 x 176	pixel	
Pixel Pitch	0.217 x 0.217 (117dpi)	mm	
Pixel Arrangement Vertical stripe		-	
Display Colors	Display Colors Black/White		
Surface Treatment	Anti-Glare	-	
Driver IC	G2	-	-

Note (1): Not including the FPC.

Rev.: 04 Page: 9 of 29 Date: 2016/03/09





1.5 Mechanical Specifications

Table 1-2 Mechanical Specification

Item		Min.	Тур.	Max.	Unit	Note
	Horizontal(H)	70.12	70.42	70.72	mm	
Glass Size	Vertical(V)	45.50	45.80	46.10	mm	
	Thickness(T)	0.8	1.0	1.2	mm	(1)
Weight		-	-	5.2	6.3	g

Note (1): Not including the Masking Film.

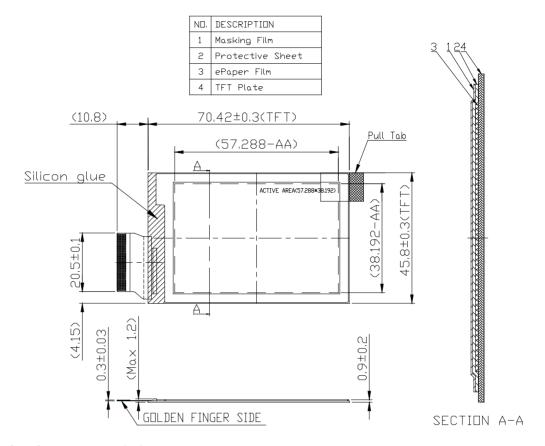
Table 1-3 FPC Specification

Item	Pin numbers	Pitch (mm)	Connector	Note
Golden Finger	40	0.5	STARCONN 089H40 or HRS TF31-40S or Compatible	

Rev.: 04 Page: 10 of 29 Date: 2016/03/09



Figure 1-1 EPD Drawing



General tolerance: ±0.3mm



2 Absolute Maximum Ratings

2.1 Absolute Ratings of Environment

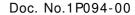
Table 2-1 Absolute Ratings of Environment

Itom	Cumbal	Value		Lloit	Note	
Item	Symbol	Min.	Max.	Unit	Note	
Storage Temperature ^(*)	T _{ST}	-20	+ 60	º C	(1), (3)	
Operating Ambient Temperature	T _{OP}	0	+ 50	º C	(1), (2), (3)	

Note (1):

- (a) 90 % RH Max. (Ta \leq 40 $^{\circ}$ C), where Ta is ambient temperature.
- (b) Wet-bulb temperature should be 39 $^{\circ}$ C Max. (Ta > 40 $^{\circ}$ C).
- (c) No condensation and no frost.
- (d) If users like to put the EPD under some extreme condition (e.g. + 60C, < 40% RH), the lifetime of EPD may be shorter than warranty lifetime. Please contact PDi sales respective for details.
- Note (2): The temperature of panel display surface area should be 0 °C Min. and 50 °C Max. Refresh time depends on operating temperature.
- Note (3): In order to keep good performance of EPD, please refer to precaution for storage condition.

Rev.: 04 Page: 12 of 29 Date: 2016/03/09





2.2 Reliability Test Item

Table 2-2 Reliability Test Items

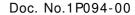
Item	Test Condition	Remark
High Temperature Operation	50 °C / 30 % RH for 240h	(1) (2)
Low Temperature Operation	0 °C for 240h	(1) (2)
High Temperature/Humidity Operation	40 °C / 90 % RH for 168h	(1) (2)
High Temperature Storage	60 °C / 26 % RH for 240h	(1)(2)(3)
Low Temperature Storage	-20 ℃ for 240h	(1)(2)(3)
High Temperature/Humidity Storage	50 °C / 80 % RH for 168h	(1)(2)(3)
Thermal Cycles (Non-operation)	1 Cycle:- 20° C/30min \rightarrow 60° C/30min, for 100 Cycles	(1)(2)(3)
Package Drop Test	Drop from 97cm. (ISTA) 1 corner, 3 edges, 6 sides. One drop for each.	(1)(2)(3)
Package Random Vibration Test	1.15Grms, 1Hz ~ 200Hz. (ISTA)	(1)(2)(3)

Note (1): No condensation and no frost during test. End of test, function, mechanical, and optical shall be satisfied.

Note (2): The test result and judgment are based on PDI's 1bit driving waveform, driving fixture and driving system.

Note (3): Stay white pattern for storage and non-operation test.

Rev.: 04 Page: 13 of 29 Date: 2016/03/09





3 Electrical Characteristics

3.1 Absolute Maximum Ratings of Panel

Table 3-1 Absolute Maximum Ratings of Panel

Devementer	Cumbal	\	/alue	l loit	Note
Parameter	Symbol	Min	Max	Unit	
Digital Power	V_{DD}	-0.3	6.0	V	
Analog Power	V _{CC}	-0.3	6.0	V	
Ground	V_{SS}		-	-	Connect V _{SS} to Ground

 $T_a = 25 \pm 2 \circ C$

3.2 Recommended Operation Conditions of Panel

Table 3-2 Recommended Operation Conditions of Panel

Paramotor		Symbol		Value		Unit	Note
Para	Parameter		Min	Тур	Max	Offic	
Digita	l Power	V_{DD}	2.3	3.0	3.6	V	
Analog	g Power	V _{CC}	2.3	3.0	3.6	V	
Input	High	V _{IH}	$0.8V_{DD}$	1	V_{DD}	V	/CS, ID, SCLK,
Voltage	Low	V _{IL}	V_{SS}	-	0.2V _{DD}	V	SI, / RESET
Output	High	V _{OH}	0.8V _{DD}	-	V _{DD}	V	I _{OH} = 0.5mA, SO, BUSY
Voltage	Low	V _{OL}	$V_{\rm SS}$	ı	0.2V _{DD}	V	I _{OL} =-0.5mA, SO, BUSY
Input	High	I _{IH}	1	1	2.0	uA	
Leakage Current	Low	I _{IL}	-	1	-2.0	uA	
Input Curre	ent	I _{DD} + I _{CC}	-	5	10	m A	(1),(2),(3)

Rev.: 04 Page: 14 of 29 Date: 2016/03/09



DC/DC Inrush Current	I _{PEAK}	-	30	90	m A	(1),(2),(3)
----------------------	-------------------	---	----	----	-----	-------------

 $T_a = 25 \pm 2 \, {}^{\circ}C$

Note (1):

Figure 3-1 Test Pattern of Panel

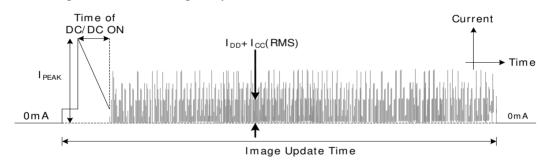


These currents are tested with PDI test jig.

Note (2):

 $V_{DD} = V_{CC} = 3.0 V$

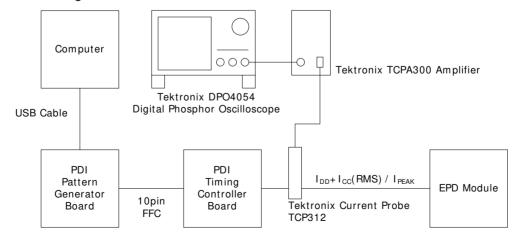
Figure 3-2 Image Update Current Profile



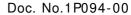
The "Time of DC/DC ON" which contains the some current peak of $V_{\text{GH}}/V_{\text{DH}}/V_{\text{GL}}/V_{\text{DL}}/V_{\text{COM}}.$

Note (3):

Figure 3-3 Current Measurement



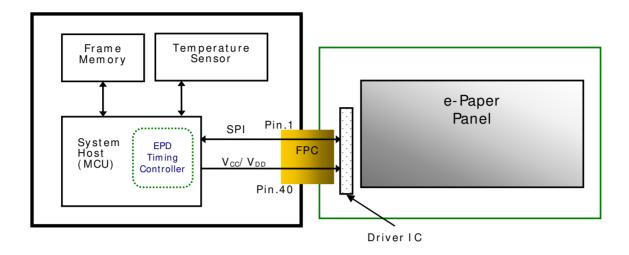
Rev.: 04 Page: 15 of 29 Date: 2016/03/09

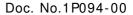




4 Application Circuit Block Diagram

Figure 4-1 Application Circuit Block Diagram







5 Terminal Pin Assignment & Reference Circuit

5.1 Terminal Pin Assignment

Table 5-1 Terminal Pin Assignment

No.	Signal	Туре	Connected to	Function	
1	/CS	1	Tcon	Chip Select. Low enable	
2	BUSY	0	Tcon	When BUSY = HIGH, EPD stays in busy state that EPD ignores any input data from SPI	
3	ID	I	Ground	Connect ID to ground	
4	SCLK	I	Tcon	Clock for SPI	
5	SI	I	Tcon	Serial input from Timing Controller to EPD	
6	SO	0	Tcon	Serial output from EPD to Timing Controller	
7	/RESET	I	Tcon	Reset signal. Low enable	
8	PWRON	-	NC	For 2.7" is keep open.	
9	V_{CL}	С	Capacitor		
10	C42P	-	NC	Not Connected	
11	C42M	-	NC	Not Connected	
12	C41P	С	Charge-Pump		
13	C41M	С	Capacitor		
14	C31M	С	Charge-Pump		
15	C31P	С	Capacitor		
16	C21M	С	Charge-Pump		
17	C21P	С	Capacitor		
18	C16M	С	Charge-Pump		
19	C16P	С	Capacitor		
20	C15M	С	Charge-Pump		
21	C15P	С	Capacitor		

Rev.: 04 Page: 17 of 29 Date: 2016/03/09



No.	Signal	Туре	Connected to	Function
22	C14M	С	Charge-Pump	
23	C14P	С	Capacitor	
24	C13M	С	Charge-Pump	
25	C13P	С	Capacitor	
26	C12M	С	Charge-Pump	
27	C12P	С	Capacitor	
28	C11M	С	Charge-Pump	
29	C11P	С	Capacitor	
30	V _{COM_DRIVER}	RC	Resistor & Capacitor	The signal duty cycle can drive VCOM voltage from source driver IC
31	V _{CC}	Р	V _{cc}	Power supply for analog part of source driver
32	V_{DD}	Р	V_{DD}	Power supply for digital part of source driver
33	V_{SS}	Р	Ground	
34	V_{GH}	С	Capacitor	
35	V_{GL}	С	Capacitor	
36	V_{DH}	С	Capacitor	
37	V_{DL}	С	Capacitor	
38	BORDER	I	-	Connect to V_{DL} via control circuit for white frame border
39	V _{ST}	Р	V _{COM_PANEL}	
40	V _{COM_PANEL}	С	Capacitor	V _{COM} to panel

Note:

Type: I: Input O: Output

C: Capacitor RC: Resistor and Capacitor

P: Power

Rev.: 04 Page: 18 of 29 Date: 2016/03/09



5.2 Reference Circuit

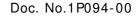
when power on

Figure 5-1 EPD Reference Circuit

INPUT Connect to Timing Controller SPI Connect to Timing Controller GPIO 40PIN 0.5mm PITCH CONNECTOR/PAD EPD PANEL PCB SIDE Connect to Timing Controller SPI Connect to Timing Controller SPI Connect to Timing Controller SPI Connect to Timing Controller GPIC C3 2.2u/25V/Y5V C4 2.2u/25V/Y5V 2.2u/25V/Y5V 2.2u/25V/Y5V 2.2u/16V/Y5V C8 2.2u/16V/Y5V C9 2.2u/16V/Y5V C10 C12M C12P C11M C11P VCOM_DRIVER VCC VDD VSS VGH VGH VDH VDH VDH VDL BORDER VST VCOM_PANEL ZIF-40-0.5 Connect to Power Ground C10 2.2u/16V/Y5V R1 VCOM DRIVE Connect to Power Switch 2K/5% VCC Connect to a MOS Switch to prevent leakage current 2u/25V/Y5V VGH Q1 015 2.2u/25V/Y5V 2.2u/25V/Y5V Connect to Timing Controller GPIO Q2 C16 2N7002KW BORDER DISCHARGE: set high for EPD discharge when EPD power off 100K/5% Connect to Timing Controller GPIO BORDER Control: Square Pulse

Note: (1) V_{DD} and V_{CC} must be discharged promptly after power off.

Rev.: 04 Page: 19 of 29 Date: 2016/03/09





6 Optical Characteristics

6.1 Test Conditions

Table 6-1 Optical Measurement Conditions

Item	Symbol	Value	Unit
Ambient Temperature	Ta	25±2	ō C
Ambient Humidity	На	50±10	% RH
Supply Voltage	V _{CC} & V _{DD}	3.0	V

Note: Measure optical at RT (Room Temperature) after pattern update at 25 °C.

6.2 Optical Specifications

6.3 Optical

Table 6-2 Optical Measurement with D65 light source

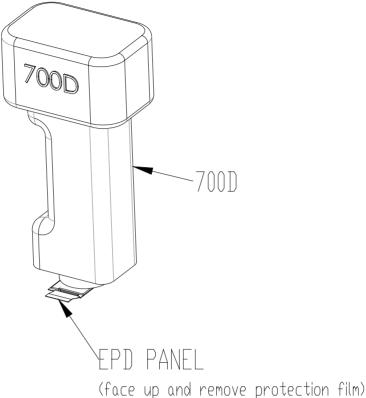
l t a ma	Cymhal		Rating			Niete
Item	Symbol	Min.	Тур.	Max.	Unit	Note
Contrast ratio	CR	1	7:1	1	ı	$\theta x = \theta y = 0$ (1),(2),(3),(4)
Refresh time	Tr	1	3	1	sec	(3)
White	Wx	-	0.308	-	-	$\theta x = \theta y = 0$ (1),(4)
Chromaticity	Wy	-	0.331	-		
Reflectance	R%	-	32	-	%	(1),(4)

Note (1): Panel is driven by PDI waveform without masking film and optical measurement by CM-700D with D65 light source and SCE mode.

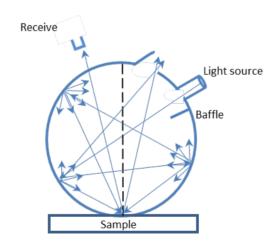
Rev.: 04 Page: 20 of 29 Date: 2016/03/09

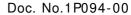


Figure 6-1 Optical measurement



SCE mode

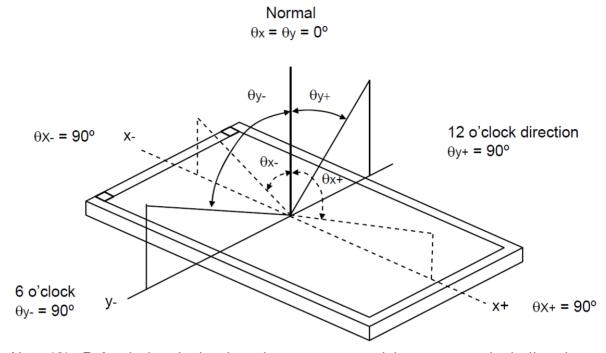






Note (2): Definition of Viewing Angle (θx , θy):

Figure 6-2 Definition of Viewing Angle to Measure Contrast Ratio



- Note (3): Refresh time is the time that e-paper particles move not including the power on and off time. The refresh time is measured at 25 °C. The refresh time and contrast ratio varies due to different films, display performance requirements, and ambient temperatures.
- Note (4): Contrast ratio (C.R.): The Contrast ratio is calculated by the following expression. C.R. = (R% White) / (R% Black). Reflectance is measured at 120 seconds after refresh.

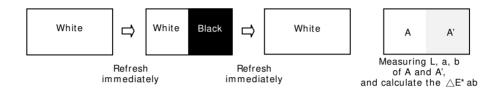
Rev.: 04 Page: 22 of 29 Date: 2016/03/09



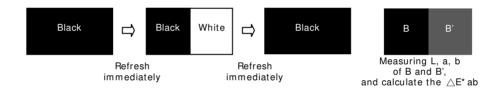
6.4 Ghosting

Below are two test methods to verify that ghosting within an acceptable range. Test 1 and Test 2 use measured data to calculate Delta E which is a single number representing the distance between two colors in a 3 dimensional color space. Test 1 and Test 2 are performed at 25 °C.

Test 1: White to Black Ghosting



Test 2: Black to White Ghosting



The formula is used to calculate Test1 and Test2. For example of Test 2: $\Delta E^* ab = [(L_B - L_{B'})^2 + (a_B - a_{B'})^2 + (b_B - b_{B'})^2]^{1/2}$

Table 6-3 Measurement of Ghosting

ltom	Rating				
Item	Min.	Тур.	Max.		
Test 1 △E*ab	-	-	2		
Test 2 △E*ab	-	-	2		

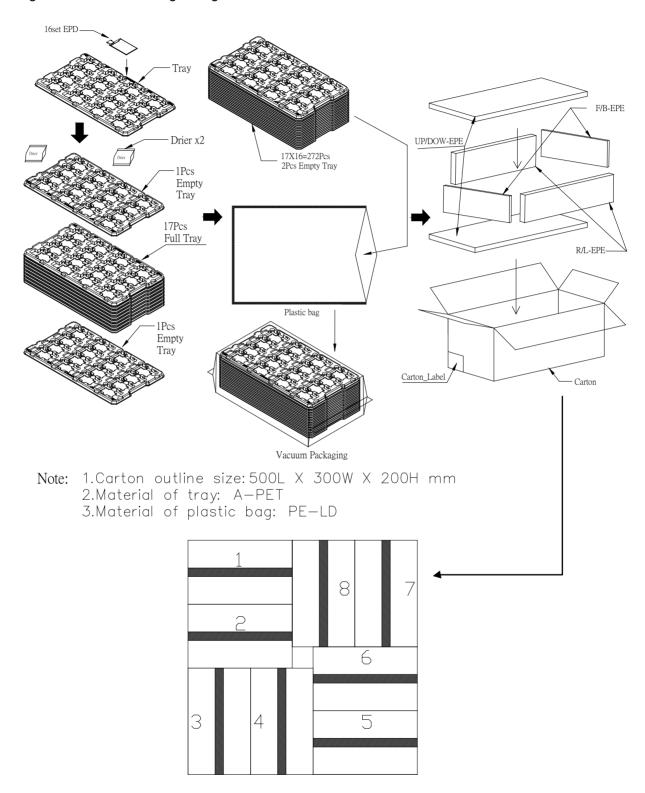
Note: Panel is driven by PDI waveform without masking film and optical measurement by CM-700D with D65 light source and SCE mode.

Rev.: 04 Page: 23 of 29 Date: 2016/03/09



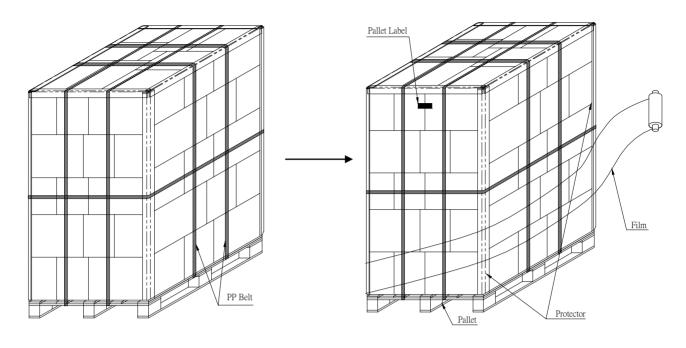
7 Packing

Figure 7-1 Packing Diagram



Rev.: 04 Page: 24 of 29 Date: 2016/03/09

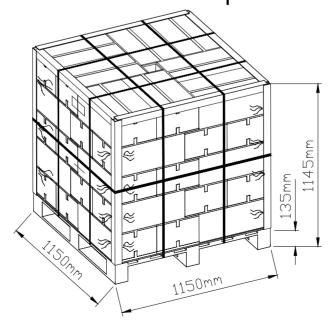




272(pcs)x40(BOX)=10,880pcs

	2.7" EPD BOX
N.W. :	1.42Kg
G.W. :	4.78 Kg

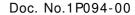
Sea / Land / Air Transportation



Rev.: 04 Page: 25 of 29 Date: 2016/03/09

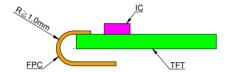
8 Precautions

- (1) The EPD Panel / Module is manufactured from fragile materials such as glass and plastic, and may be broken or cracked if dropped. Please handle with care. Do not apply force such as bending or twisting to the EPD panel.
- (2) It is recommended to assemble or install EPD panels in a clean working area. Dust and oil may cause electrical shorts or degrade / scratch / dent the protection sheet film.
- (3) Do not apply pressure to the EPD panel in order to prevent damaging it.
- (4) Do not connect or disconnect the interface connector while the EPD panel is in operation.
- (5) Please support as the bezel with your finger while connecting the interface cable such as the FPC.
- (6) Do not stack the EPD panels / Modules.
- (7) Do not press the FPC on the glass edge or Pull FPC up / down to 90°.
- (8) Do not touch the FPC lead connector.
- (9) Do not touch IC bonding area. It may scratch TFT lead or damage IC function.
- (10) Wear a Wrist Strap (Grounding connect) when handling and during assembly. Semiconductor devices are included in the EPD Panel / Module and they should be handled with care to prevent any electrostatic discharge (ESD). (An Ion Fan may be needed in assembly operation to reduce ESD risk.)
- (11) Keep the EPD Panel / Module in the specified environment and original packing boxes when storage in order to avoid scratching and keep original performance.
- (12) Do not disassemble or reassemble the EPD panel.
- (13) Use a soft dry cloth without chemicals for cleaning. Please don't press hard for cleaning because the surface of the protection sheet film is very soft and without hard coating. This behavior would make dent or scratch on protection sheet.
- (14) Please be mindful of moisture to avoid its penetration into the EPD panel, which may cause damage during operation.
- (15) It's low temperature operation product. Please be mindful the temperature different to make frost or dew on the surface of EPD panel. Moisture may penetrate into the EPD panel because of frost or dew on surface of EPD panel, and makes EPD panel damage.
- (16) High temperature, high humidity, sunlight or fluorescent light may degrade the EPD panel's performance. Please do not expose the unprotected EPD panel to high temperature, high humidity, sunlight, or fluorescent for long periods of time. Please store the EPD panel in controllable environment of warehouse and original package: Without sunlight, without condensation, a temperature range of 15°C to 35°C, and humidity from 30% RH to 60% RH.
- (17) The label ink used for marking the Panel ID number is erased easily by solvent. Please avoid using solvent to clean the EPD panel.
- (18) The EPD is vacuum packed.
- (19) Before approved by PDI and customer, products and product specifications may be subject to change without notice. Confirm that you have received the latest product standards or specifications before final design, purchase or use.
- (20) PDI makes every attempt to ensure that its products are of high quality and reliability.





- However, contact PDI sales office before using the product in an application that demands especially high quality and reliability or where its failure or malfunction may directly threaten human life or cause risk of bodily injury, such as aerospace, aeronautics, nuclear power, combustion control, transportation, traffic, safety equipment or medical equipment for life support.
- (21) Design your application so that the product is used within the ranges guaranteed by PDI particularly for maximum rating, operating supply voltage range, heat radiation characteristics, installation conditions and other characteristics. PDI bears no responsibility for failure or damage when used beyond the guaranteed ranges. Even within the guaranteed ranges, consider normally foreseeable failure rates or failure modes in semiconductor devices and employ systemic measures such as fail safes, so that the equipment incorporating PDI product does not cause bodily injury, fire or other consequential damage due to operation of the PDI product.
- (22) This product is not designed to be radiation resistant.
- (23) Please keep R≥1.0mm when bend for assembly.



Rev.: 04 Page: 27 of 29 Date: 2016/03/09



9 Definition of Labels

Figure 9-1 Model Labels

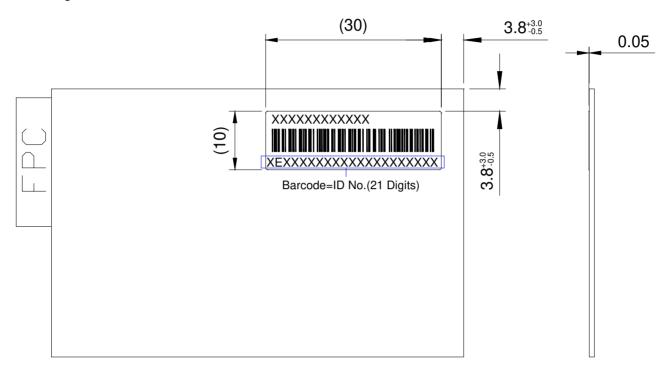
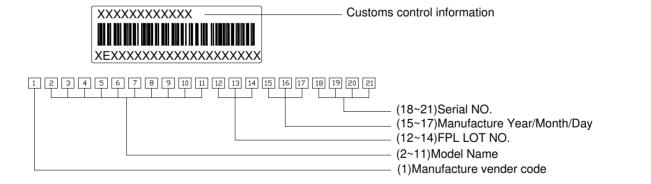


Figure 9-2 Definition of Model Labels



Rev.: 04 Page: 28 of 29 Date: 2016/03/09



Figure 9-3 Carton Label

Bar Code=Model Name. + Carton Serial No. + Q'TY. (Code 128)

Model Name. Carton Serial No. Q'TY. (3 Digits)

EXXXXXXXXX LXXXXXXXX Q'TY:XXX RoHS

(10 Digits) (9 Digits) Customs control information

FPL Lot No. (6 Digits)

Carton Label

Figure 9-4 Pallet Label



Bar Code=Model Name.+Pallet Serial No.+Q'TY.(22 Digits)

Pallet Label

Rev.: 04 Page: 29 of 29 Date: 2016/03/09